

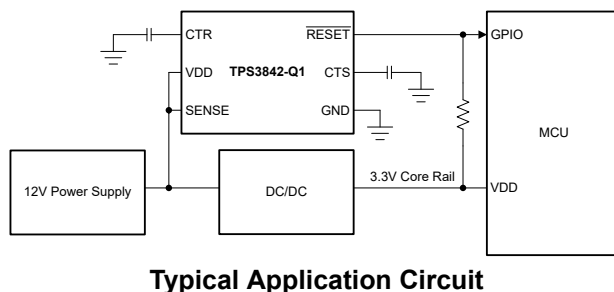
# TPS3842-Q1 Automotive 42V Small Size, 850nA Undervoltage Supervisor With Programmable Delay and De-Glitch

## 1 Features

- AEC-Q100 qualified with the following results:
  - Device temperature grade 1:  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  ambient operating temperature  $T_A$
  - Device HBM ESD classification level 2
  - Device CDM ESD classification level C7B
- Wide supply voltage range: 1.9V to 42V
- VDD, SENSE, and  $\overline{\text{RESET}}$  are rated to 42V
- Very low quiescent current: 850nA (typical)
- High threshold accuracy: 0.5% (typical)
- Fixed internal threshold voltages: 2.7V to 9.5V
- Adjustable voltage variant: 0.7V
- Capacitor programmable adjustable delay time with CTR pin
- Capacitor programmable deglitch delay time with CTS pin
- Open-drain, active-low output
- Temperature range:  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$
- Small size: SOT563 (DRL)

## 2 Applications

- [ADAS domain controller](#)
- [Automotive gateway](#)
- [Automotive head unit](#)
- [Digital cockpit processing unit](#)
- [Telematics control unit](#)
- [Driver monitoring](#)



## 3 Description

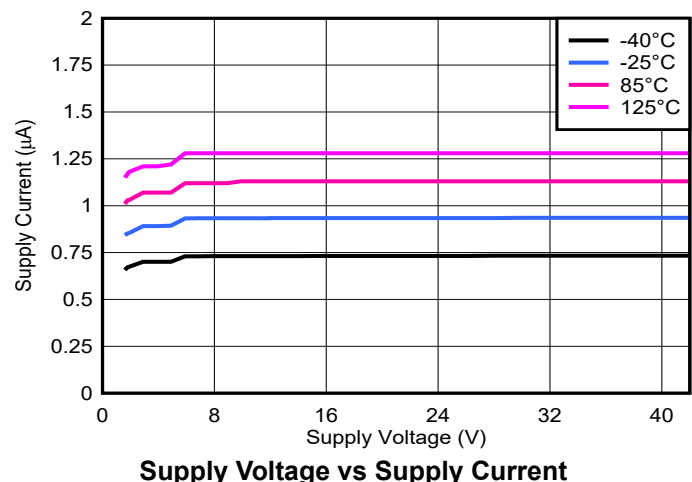
The TPS3842-Q1 is an automotive 42V input voltage supervisor with 850nA  $I_{DD}$  and 1.5% accuracy, and a fast detection time. The TPS3842-Q1 can be connected directly to 12V battery for continuous monitoring of undervoltage (UV) conditions. The TPS3842-Q1 comes in a small DRL package for size constraint applications. Built-in hysteresis on the SENSE pin prevents false reset signals when monitoring a supply voltage rail. 1%, 5%, and 10% hysteresis voltage options are available to offer design flexibility to support voltage transients.

SENSE is decoupled from VDD and can monitor higher and lower voltages than VDD. Fixed threshold variants provide accurate low-Iq voltage monitoring. Adjustable threshold variants offer flexible undervoltage threshold setting with external resistors. TPS3842 offers capacitor programmable de-glitch on the SENSE with the CTS pin and capacitor programmable reset delay timing with the CTR pin.

### Device Information

PART NUMBER	PACKAGE <sup>(1)</sup>	BODY SIZE (NOM) <sup>(2)</sup>
TPS3842-Q1	SOT563 (6)	1.20mm x 1.60mm

- For all available packages, see the orderable addendum at the end of the data sheet.
- The package size (length × width) is a nominal value and includes pins, where applicable.

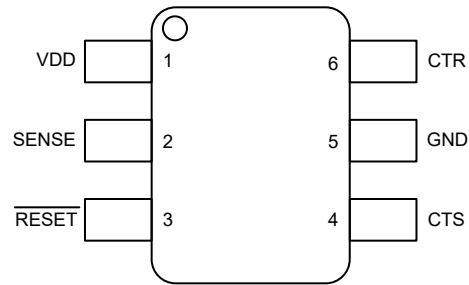


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## 5 Pin Configuration and Functions



**Figure 5-1. DRL Package  
6-Pin SOT563  
Top View**

**Table 5-1. Pin Functions**

PIN		I/O	DESCRIPTION
NAME	SOT563		
V <sub>DD</sub>	1	I	Supply voltage pin.
SENSE	2	I	Sense input. Monitors input voltage based on internal voltage threshold. See <a href="#">Section 8.3.1</a> for more details.
RESET	3	O	Output reset signal. Connect RESET to pull up voltage using a pull up resistance. See <a href="#">Section 8.3.5</a> for more details.
CTS	4	I	Sense time delay: Capacitor programmable sense delay: CTS pin offers a user adjustable sense delay time when asserting a reset condition. See <a href="#">Section 8.3.3</a> for more details.
GND	5	—	Ground pin.
CTR	6	I	Reset output: User-programmable reset time delay for RESET pin. Connect an external capacitor for adjustable time delay or leave the pin floating for the shortest delay. See <a href="#">Section 8.3.4</a> for more details.

## 6 Specification

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
Voltage	V <sub>DD</sub>	-0.3	50	V
Voltage	V <sub>SENSE</sub>	-0.3	50	V
Voltage	V <sub>RESET</sub>	-0.3	50	V
Voltage	V <sub>CTR</sub>	-0.3	5.5	V
Voltage	V <sub>CTS</sub>	-0.3	5.5	V
Current	I <sub>RESET</sub>		±40	mA
Temperature <sup>(2)</sup>	Operating junction temperature, T <sub>J</sub>	-55	150	°C
	Operating free-air temperature, T <sub>A</sub>	-55	150	°C
	Storage temperature, T <sub>stg</sub>	-65	150	°C

- (1) Stresses beyond values listed under Absolute Maximum Ratings can cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.
- (2) As a result of the low dissipated power in this device, the operating temperature is assumed that T<sub>J</sub> = T<sub>A</sub>.

### 6.2 ESD Ratings

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human body model (HBM), per AEC Q100-002 <sup>(1)</sup>	±2000	V
		Charged device model (CDM), per AEC Q100-011	±750	

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
V <sub>DD</sub>	Supply pin voltage	1.9		42	V
V <sub>SENSE</sub>	Sense pin voltage	0		42	V
V <sub>CTR</sub>	CTR pin voltage			5	V
V <sub>CTS</sub>	CTS pin voltage			5	V
V <sub>RESET</sub>	Output pin voltage	0		42	V
I <sub>RESET</sub>	Output pin current	0		10	mA
T <sub>J</sub>	Junction temperature (free-air temperature)	-40		125	°C

## 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		TPS3842-Q1	
		DRL	
		6 PINS	
			UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	153.4	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	86.3	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	42.8	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	2.9	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	41.2	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

At  $1.9V \leq V_{DD} \leq 42V$ , CTS = CTR = Open,  $\overline{\text{RESET}}$  Voltage ( $V_{\overline{\text{RESET}}}$ ) = 100k $\Omega$  to  $V_{DD}$ ,  $\overline{\text{RESET}}$  load = 50pF, and over the operating free-air temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $T_A = 25^{\circ}\text{C}$ .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{DD}$	Supply Voltage		1.9		42	V
$V_{POR}$	Power on reset voltage <sup>(2)</sup>	$V_{OL}(\text{max}) = 0.25V$ , $I_{OUT} = 15\mu\text{A}$			1.4	V
$V_{ITN}$	Negative-going threshold accuracy	Fixed internal threshold, $V_{ITN} = 2.7V$ to 9.5V	-1.5	$\pm 0.5$	1.5	%
$V_{ITN}$	Negative-going threshold accuracy	Adjustable internal threshold, $V_{ITN} = 700\text{mV}$	-1.5	$\pm 0.5$	1.5	%
$V_{HYS}$	Hysteresis Voltage <sup>(1)</sup>	1% Variant	0.5	1	1.5	%
$V_{HYS}$	Hysteresis Voltage <sup>(1)</sup>	5% Variant	4.5	5	5.5	%
$V_{HYS}$	Hysteresis Voltage <sup>(1)</sup>	10% Variant	9.5	10	10.5	%
$I_{DD}$	Supply current	$V_{DD} = 12V$ , $\overline{\text{RESET}} = \text{Not asserted}$		0.85	2.1	$\mu\text{A}$
$I_{SENSE}$	Input current, SENSE pin	$V_{SENSE} = V_{ITN}$ , Adjustable version	-25		25	nA
$I_{SENSE}$	Input current, SENSE pin	$V_{SENSE} = 12V$ , Fixed versions		1.35	2.5	$\mu\text{A}$
$V_{OL}$	Low level output voltage	$1.9V \leq V_{DD} < 42V$ , $I_{OUT} = 0.5\text{mA}$			400	mV
$I_{LKG}$	Open drain output leakage current	$V_{DD} = V_{\overline{\text{RESET}}} = 12V$			300	nA

(1) Hysteresis is with respect of the tripoint  $V_{ITN}$ .

(2)  $V_{POR}$  is the minimum  $V_{DD}$  voltage level for a controlled output state.

## 6.6 Timing Requirements

At  $1.9V \leq V_{DD} \leq 42V$ , CTS = CTR = Open,  $\overline{\text{RESET}}$  Voltage ( $V_{\text{RESET}}$ ) =  $100k\Omega$  to  $V_{DD}$ ,  $\overline{\text{RESET}}$  load =  $50pF$ , and over the operating free-air temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $T_A = 25^{\circ}\text{C}$ .

			MIN	NOM	MAX	UNIT
$t_{PD}$	Propagation detect delay <sup>(1) (2)</sup>	CTS = Open, ADJ $V_{ITN}$		10	20	$\mu\text{s}$
$t_{PD}$	Propagation detect delay <sup>(1) (2)</sup>	CTS = Open, Fixed $V_{ITN}$		10	20	$\mu\text{s}$
$t_{CTS}$	Sense time delay	CTR = $0.1\mu\text{F}$		300		ms
$t_{GI} (V_{ITN})$	Glitch Immunity undervoltage $V_{IT-(UV)}$ , 20% Overdrive <sup>(1)</sup>	CTS = Open		5		$\mu\text{s}$

- (1) 20% Overdrive from threshold. Overdrive % =  $[V_{\text{SENSE}} - V_{ITN}] / V_{ITN}$   
 (2)  $t_{PD}$  measured from threshold trip point ( $V_{ITN}$ ) to  $\overline{\text{RESET}}$   $V_{OL}$  voltage

## 6.7 Switching Characteristics

At  $1.9V \leq V_{DD} \leq 42V$ , CTS = CTR = Open,  $\overline{\text{RESET}}$  Voltage ( $V_{\text{RESET}}$ ) =  $100k\Omega$  to  $V_{DD}$ ,  $\overline{\text{RESET}}$  load =  $50pF$ , and over the operating free-air temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $T_A = 25^{\circ}\text{C}$ .

			MIN	NOM	MAX	UNIT
$t_D$	Reset time delay	CTR = Open		250		$\mu\text{s}$
$t_{CTR}$	Reset time delay	CTR = $0.1\mu\text{F}$		300		ms
$t_{CTR}$	Reset time delay	CTR = $3.52\mu\text{F}$		10		s
$t_{SD}$	Startup delay <sup>(1)</sup>			300		$\mu\text{s}$

- (1) During the power-on sequence,  $V_{DD}$  must be at or above  $V_{DD(MIN)}$  for at least  $t_{SD} + t_D + t_{CTR}$  before the output is in the correct state.

## 6.8 Timing Diagram

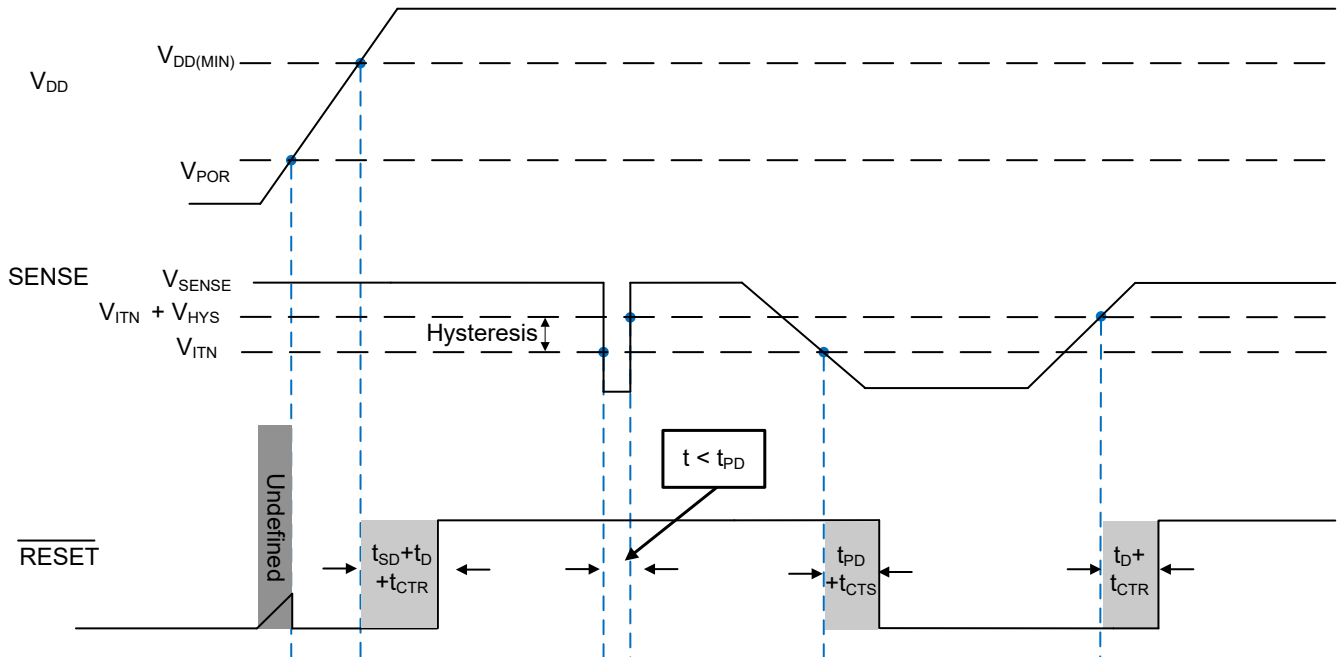
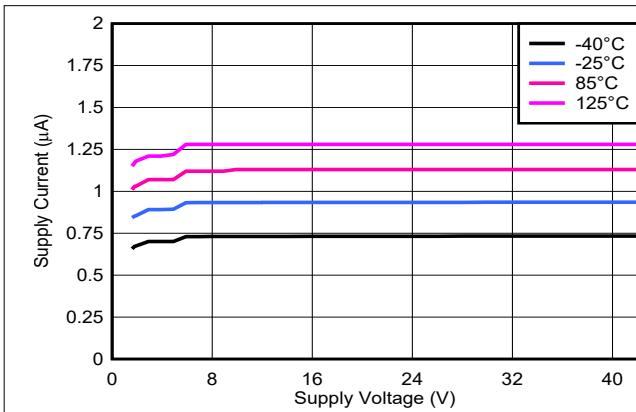


Figure 6-1. Timing Diagram

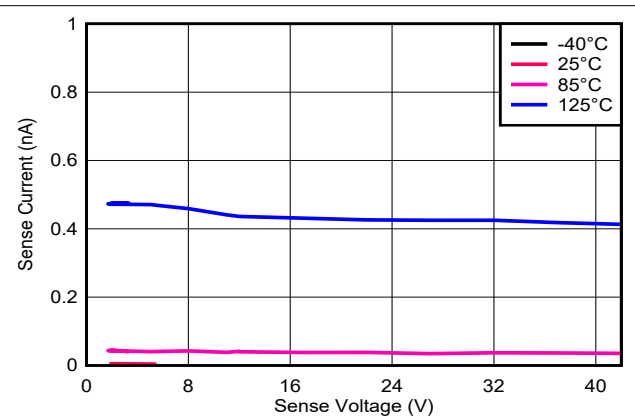


## 7 Typical Characteristics

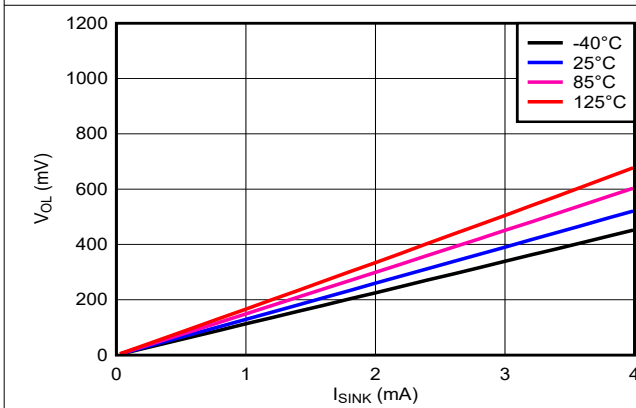
At  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ ,  $R_{L\text{RESET}} = 100\text{k}\Omega$ , and  $C_{L\text{RESET}} = 50\text{pF}$ , unless otherwise noted.



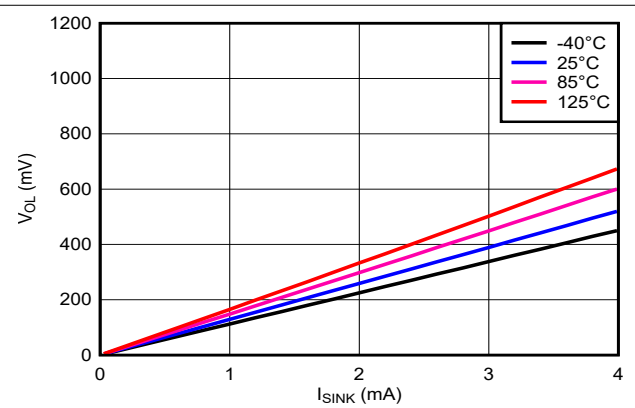
**Figure 7-1. Supply Current vs Supply Voltage**



**Figure 7-2.  $V_{\text{SENSE}}$  vs  $I_{\text{SENSE}}$  ( $V_{\text{ITN}} = 700\text{mV}$ )**



**Figure 7-3. RESET Current vs  $V_{\text{OL}}$  ( $V_{\text{DD}} = 3.3\text{V}$ )**



**Figure 7-4. RESET Current vs  $V_{\text{OL}}$  ( $V_{\text{DD}} = 12\text{V}$ )**

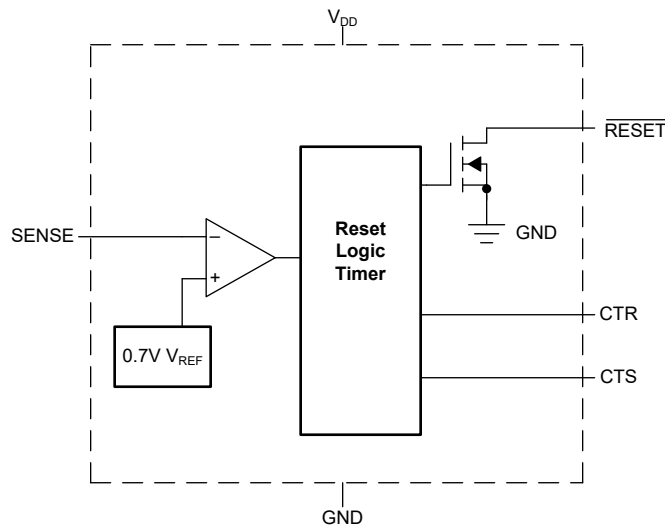
## 8 Detailed Description

### 8.1 Overview

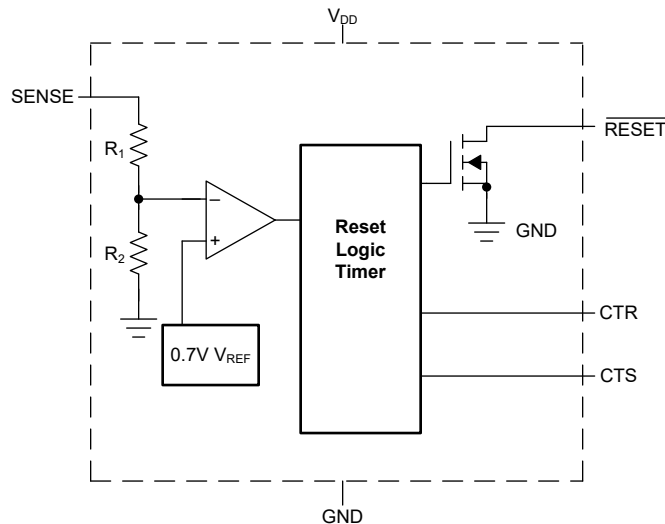
The TPS3842-Q1 high voltage supervisor product family is designed to assert a  $\overline{\text{RESET}}$  signal when the SENSE pin voltage drops below  $V_{\text{ITN}}$  after a user-adjustable time. The  $\overline{\text{RESET}}$  output remains asserted for a user-adjustable time after SENSE voltages returns above the respective threshold and hysteresis.

VDD, SENSE and  $\overline{\text{RESET}}$  pins can support 42V continuous operation. Both VDD, SENSE, and  $\overline{\text{RESET}}$  voltage levels can be independent of each other. The TPS3842-Q1 features capacitor programmable sense time delay (CTS) to set a minimum duration of a undervoltage event before  $\overline{\text{RESET}}$  is asserted. CTS feature also functions as a programmable de-glitch to avoid false resets. The TPS3842-Q1 also features a capacitor programmable reset time delay (CTR) to set a minimum duration of  $\overline{\text{RESET}}$  assertion after a undervoltage event.

### 8.2 Functional Block Diagram



**Figure 8-1. Adjustable-Voltage Version**



**Figure 8-2. Fixed-Voltage Version**

## 8.3 Feature Description

A broad range of voltage threshold and hysteresis options are available for the TPS3842-Q1, allowing this device to be used in a wide array of applications. Reset threshold voltages can be factory-set from adjustable 0.7V or fixed from 2.7V to 9.5V. The adjustable variant can be set to any voltage above 0.7V using an external resistor divider. Connecting a capacitor between  $C_{TR}$  and GND allows the designer to select any reset delay period up to 10s. Connecting a capacitor between CTS and GND allows the designer to select any sense delay period up to 10s.

### 8.3.1 SENSE Input

The SENSE input provides a pin at which any system voltage can be monitored. If the voltage on this pin drops below  $V_{ITN}$  for a  $T_{PD}+T_{CTS}$  time interval, then **RESET** is asserted. The comparator has a built-in hysteresis to suppress unintended **RESET** assertions and de-assertions. For noisy environments, good analog design practice is to put a 1nF bypass capacitor on the SENSE input to reduce sensitivity to transients and layout parasitics or leverage the CTS feature to set a minimum fault time interval before **RESET** is asserted.

Figure 8-3 illustrates an example of how to adjust the voltage threshold with external resistor dividers. The resistors can be calculated depending on the desired voltage threshold and device part number. TI recommends using the 700mV threshold option when using an external resistor divider. The variant bypasses the internal resistor ladder for higher accuracy when using external resistors.

For example, consider a 12V rail,  $V_{MON}$ , being monitored for undervoltage (UV) using of the TPS3842A011DRLRQ1 variant, as shown in Figure 8-3. The monitored UV threshold, denoted as  $V_{MON-}$ , is the desired voltage where the device asserts the reset. For this example  $V_{MON-} = 5.8V$ . To assert an undervoltage reset the voltage at the sense pin,  $V_{SENSE}$ , needs to be equal to the input threshold negative,  $V_{ITN}$ . For this example variant  $V_{SENSE} = V_{ITN} = 0.7V$ . Using  $R_1$  and  $R_2$  the correlation between  $V_{MON-}$  and  $V_{SENSE}$  can be seen in Equation 1. Assuming  $R_2 = 100k\Omega$ , and  $R_1$  can be calculated as  $R_1 = 16k\Omega$ .

$$V_{SENSE} = V_{MON-} \times (R_2 \div (R_1 + R_2)) \quad (1)$$

The TPS3842-Q1 hysteresis depends on the configuration selected. For the reset signal to become deasserted,  $V_{MON}$  must go above  $V_{ITN} + V_{HYS}$ . For this example variant a 1% voltage threshold hysteresis was selected. Therefore,  $V_{MON}$  equals 5.858V when the reset signal becomes deasserted. If a 10% hysteresis option was instead used,  $V_{MON}$  equals 6.38V when the reset signal becomes deasserted.

There are inaccuracies that must be taken into consideration while adjusting voltage thresholds. Aside from the tolerance of the resistor divider, there is an internal resistance of the SENSE pin that can affect the accuracy of the resistor divider. Although expected to be very high impedance, users are recommended to calculate the values for the design specifications. The internal SENSE resistance ( $R_{SENSE}$ ) can be calculated by the SENSE voltage ( $V_{SENSE}$ ) divided by the SENSE current ( $I_{SENSE}$ ) as shown in Equation 3.  $V_{SENSE}$  can be calculated using Equation 1 depending on the resistor divider and monitored voltage.  $I_{SENSE}$  can be calculated using Equation 2.

$$I_{SENSE} = [(V_{MON} - V_{SENSE}) \div R_1] - (V_{SENSE} \div R_2) \quad (2)$$

$$R_{SENSE} = V_{SENSE} \div I_{SENSE} \quad (3)$$

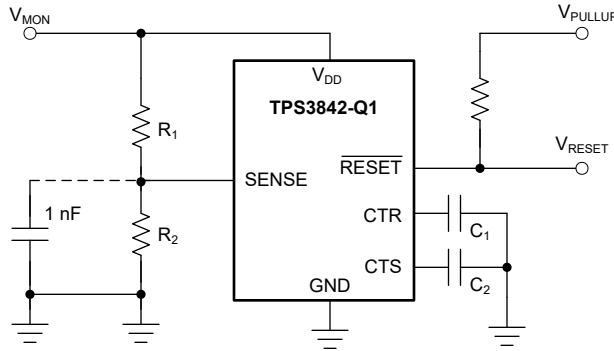


Figure 8-3. Using the TPS3842A011DRLRQ1 to Monitor a User-Defined Threshold Voltage

### 8.3.2 SENSE Hysteresis

TPS3842-Q1 device offers built-in hysteresis around the UV threshold to avoid erroneous  $\overline{\text{RESET}}$  deassert. The hysteresis ( $V_{\text{HYS}}$ ) is opposite to the threshold voltage for undervoltage options hysteresis is added to the negative threshold ( $V_{\text{ITN}}$ ).

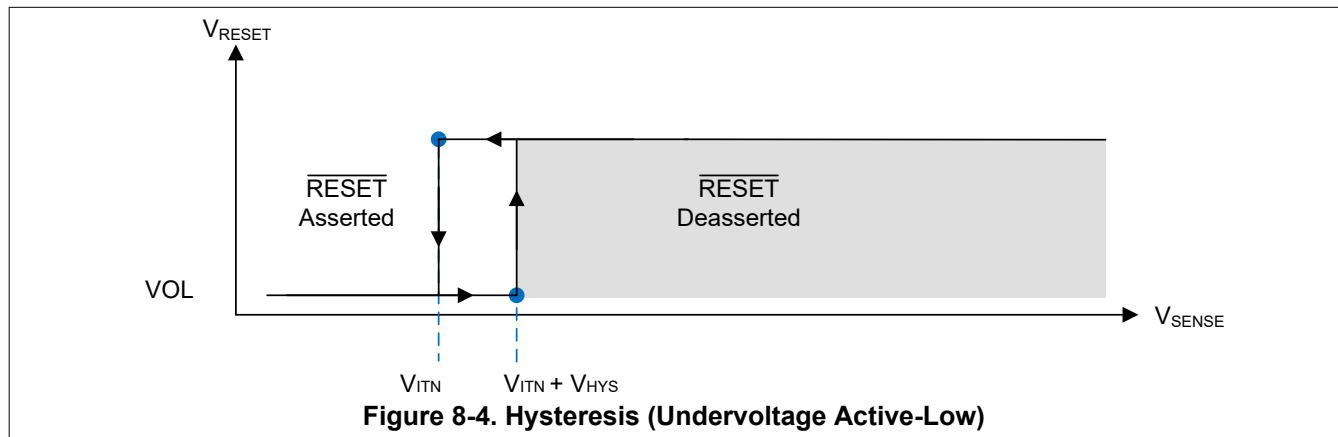


Table 8-1. Common Adjustable Hysteresis Lookup Table

Part Number	DEVICE HYSTERESIS OPTION
TPS3842Axx1DRLRQ1	1%
TPS3842Axx5DRLRQ1	5%
TPS3842Axx0DRLRQ1	10%

Knowing the amount of hysteresis voltage, the release voltage for the undervoltage (UV) channel is ( $V_{\text{ITN}} + V_{\text{HYS}}$ ). Hysteresis is dependent on the device  $V_{\text{ITN}}$  including  $V_{\text{ITN}}$  accuracy and deviations.

#### Undervoltage (UV)

$$V_{\text{ITN}} = 700\text{mV}$$

$$\text{Voltage Hysteresis } (V_{\text{HYS}}) = 1\% = V_{\text{ITN}} \times 1\% = 7\text{mV}$$

$$\text{Hysteresis Accuracy} = +0.5\% \text{ to } +1.5\% = 6.65\text{mV to } 7.10\text{mV}$$

$$\text{Release Voltage} = V_{\text{ITN}} + V_{\text{HYS}} = 706.65\text{mV to } 707.105\text{mV}$$

### 8.3.3 Selecting the SENSE Delay Time

TPS3842-Q1 has adjustable sense time delay with external capacitors.

- A capacitor on CTS programs the excursion detection on SENSE.
- No capacitor on this pin gives the fastest sense delay time indicated by  $t_{PD}$  in [Section 6.6](#).
- Parasitic capacitance on the CTS pin counts as CTS capacitance and increases  $T_{CTS}$ .

The time delay ( $t_{CTS}$ ) can be programmed by connecting a capacitor between CTS pin and GND.

The relationship between external capacitor  $C_{CTS\_EXT (typ)}$  and the time delay  $t_{CTS (typ)}$  is given by [Equation 4](#).

$$t_{CTS (typ)} = 2.858 \times C_{CTS\_EXT (typ)} \quad (4)$$

$C_{CTS\_EXT (typ)}$  is given in microfarads ( $\mu F$ )

The sense delay varies according to the external capacitor ( $C_{CTS\_EXT}$ ). The minimum and maximum variance due to the constant is show in [Equation 5](#) and [Equation 6](#):

$$t_{CTS (max)} = 3.715 \times C_{CTS\_EXT (max)} \quad (5)$$

$$t_{CTS (min)} = 2 \times C_{CTS\_EXT (min)} \quad (6)$$

There is no limit to the capacitor on CTS pin. Make sure there is enough time for the capacitor to fully discharge when a voltage fault occurs to prevent the CTS capacitor from having charge before the next fault. Also, having a too large of a capacitor value can cause very slow charge up (rise times) and system noise can cause the internal circuit to trip earlier or later near the threshold.

\* Leakages on the capacitor can effect accuracy of sense time delay.

### 8.3.4 Selecting the RESET Delay Time

TPS3842-Q1 has adjustable reset release time delay with external capacitors.

- A capacitor on CTR programs the reset time delay of the output.
- No capacitor on this pin gives the fastest reset delay time indicated by  $t_D$  in [Section 6.7](#).
- Parasitic capacitance on the CTR pin counts as CTR capacitance and increases  $t_{CTR}$ .

The time delay ( $t_{CTR}$ ) can be programmed by connecting a capacitor between CTR pin and GND.

The relationship between external capacitor  $C_{CTR\_EXT (typ)}$  and the time delay  $t_{CTR (typ)}$  is given by [Equation 7](#).

$$t_{CTR (typ)} = 2.858 \times C_{CTR\_EXT (typ)} \quad (7)$$

$C_{CTR\_EXT (typ)}$  is given in microfarads ( $\mu F$ )

The reset delay varies according to the external capacitor ( $C_{CTR\_EXT}$ ). The minimum and maximum variance due to the constant is show in [Equation 8](#) and [Equation 9](#):

$$t_{CTR (max)} = 3.715 \times C_{CTR\_EXT (max)} \quad (8)$$

$$t_{CTR (min)} = 2 \times C_{CTR\_EXT (min)} \quad (9)$$

There is no limit to the capacitor on CTR pin. Having a too large of a capacitor value can cause very slow charge up (rise times) due to capacitor leakage and system noise can cause the internal circuit to hold  $\overline{RESET}$  active.

\* Leakages on the capacitor can effect accuracy of reset time delay.

### 8.3.5 RESET Output

$\overline{RESET}$  (active low) denoted with a bar above the pin label.  $\overline{RESET}$  remains high voltage ( $V_{OH}$ , deasserted) (open-drain variant  $V_{OH}$  is measured against the pullup voltage) as long as sense voltage is in normal operation above the threshold boundary and VDD voltage is above  $V_{DD(min)}$ . If SENSE falls below  $V_{ITN}$  for a time period longer than  $t_{PD} + t_{CTS}$ ,  $\overline{RESET}$  is asserted, driving the  $\overline{RESET}$  pin to a low impedance.

Once SENSE is above  $V_{ITN} + V_{HYS}$ , a delay circuit (CTR) is enabled that holds  $\overline{RESET}$  low for a specified reset delay period. Once the reset delay has expired, the  $\overline{RESET}$  pin goes to a high impedance state.

Open-drain output requires an external pull-up resistor to hold the voltage high to the required voltage logic. Connect the pull-up resistor to the proper voltage rail to enable the output to be connected to other devices at the correct interface voltage levels.  $\overline{RESET}$  is supports pull-up voltages up to 42V and is independent of VDD and SENSE voltages.

To select the right pull-up resistor, consider system  $V_{OH}$  and the Open-Drain Leakage Current ( $I_{LKG}$ ) provided in the electrical characteristics to set the maximum pull-up resistor value. Low pull-up resistor values increase the amount of current through the internal open-drain output. The current through the open-drain output must be lower than the  $I_{\overline{RESET}}$  of the device.

## 8.4 Device Functional Modes

Table 8-2. Truth Table

SENSE > V <sub>ITN</sub>	RESET	VDD
0	L	VDD > VDD(min)
1	H	VDD > VDD(min)
0	L	VDD(min) > VDD > V <sub>POR</sub>
1	L	VDD(min) > VDD > V <sub>POR</sub>

### 8.4.1 Normal Operation (V<sub>DD</sub> > V<sub>DD(min)</sub>)

When V<sub>DD</sub> is greater than V<sub>DD(min)</sub>, the  $\overline{\text{RESET}}$  signal is determined by the voltage on the SENSE pin.

- The  $\overline{\text{RESET}}$  signal corresponds to the voltage on SENSE relative to V<sub>ITN</sub>.

### 8.4.2 Above Power-On Reset but Less Than V<sub>DD(min)</sub> (V<sub>POR</sub> < V<sub>DD</sub> < V<sub>DD(min)</sub>)

When the voltage on V<sub>DD</sub> is less than the device V<sub>DD(min)</sub> voltage, and greater than the power-on reset voltage (V<sub>POR</sub>), the  $\overline{\text{RESET}}$  signal is asserted and low impedance regardless of the voltage on the SENSE pin.

### 8.4.3 Below Power-On Reset (V<sub>DD</sub> < V<sub>POR</sub>)

When the voltage on V<sub>DD</sub> is lower than the required voltage (V<sub>POR</sub>) needed to internally pull the asserted output to GND,  $\overline{\text{RESET}}$  is undefined.

## 9 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The following sections describe in detail proper device implementation, depending on the final application requirements.

### 9.2 Typical Application

A typical application of the TPS3842-Q1 used to monitor a 12V automotive battery is shown in Figure 9-1. The open-drain  $\overline{\text{RESET}}$  output is typically connected to the  $\overline{\text{RESET}}$  input of a microprocessor to signal when the Battery is below  $V_{\text{ITN}}$ . A pullup resistor must be used to hold this line high when  $\overline{\text{RESET}}$  is not asserted. The  $\overline{\text{RESET}}$  output is undefined for voltage below  $V_{\text{POR}}$ , but this characteristic is normally not a problem because most microprocessors do not function below this voltage.

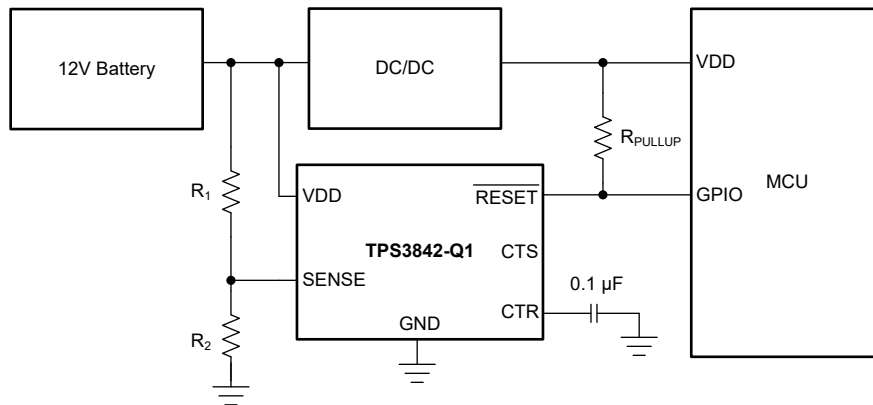


Figure 9-1. Typical Application of the TPS3842-Q1 Monitoring a 12V Power Supply

#### 9.2.1 Design Requirements

Table 9-1. Design Parameters

PARAMETER	DESIGN REQUIREMENT
Voltage Threshold	Typical UV voltage threshold 5.5V
Output logic	Open-Drain
SENSE delay	< 0.2ms
RESET delay	300ms



## 9.2.2 Detailed Design Procedure

The TPS3842-Q1 utilizes high-voltage SENSE and  $V_{DD}$  inputs to monitor a 12V battery for undervoltage. In this design example TPS3842A011DRLRQ1 is used.

The negative-going threshold voltage,  $V_{ITN}$ , is set by the device variant. In this example, the nominal supply voltage from the battery is 12V. Setting a undervoltage threshold of 5.5V (6.5V under 12V) makes sure that the device resets before supply voltage violates the allowed boundary for the DC/DC and indicates the battery is discharged. The adjustable voltage variant is chosen and  $R_1$  and  $R_2$  are adusted to meet the threshold. Assuming  $R_2$  equal to 10k $\Omega$  and  $R_1$  is calculated as 68.5k $\Omega$ . For additional information on selecting resistor values see [Section 8.3.1](#). TPS3842-Q1 also supports fixed voltage threshold variants. Threshold voltage decoding can be found in [Section 4](#).

### 9.2.2.1 Meeting the Sense and Reset Delay

The TPS3842-Q1 features both reset assertion (sense) delay,  $t_{CTS}$ , and reset deassertion (reset) delay,  $t_{CTR}$ . [Section 8.3.3](#) and [Section 8.3.4](#) show how to set the timings for the capacitor-programmable delays. The application requires less than 0.2ms sense delay, thus no capacitor is used and CTS is left open. The application requires greater than 300ms reset delay, thus a 0.1 $\mu$ F capacitor is used.

### 9.2.3 Application Curve

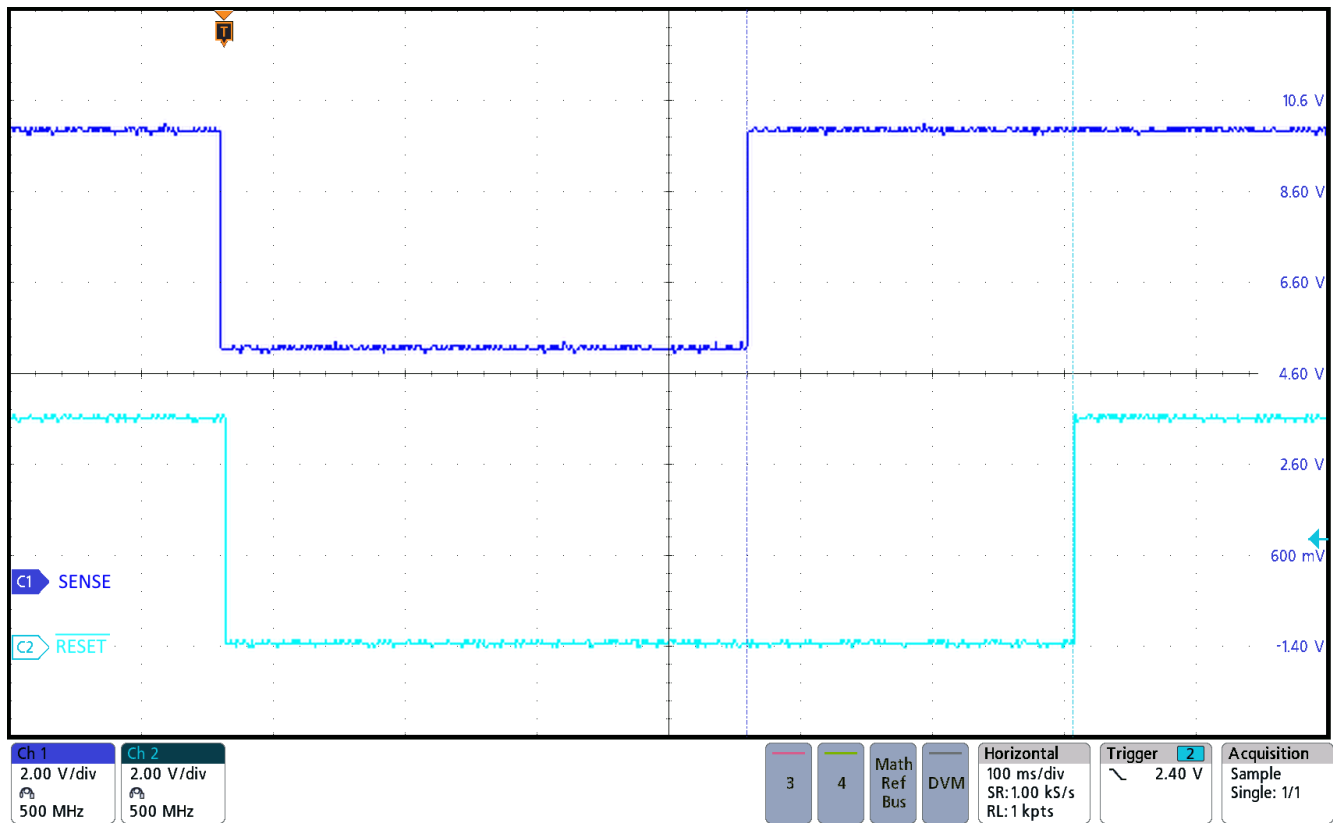


Figure 9-2. TPS3842-Q1 Detecting Undervoltage Fault and  $\overline{\text{RESET}}$  Recovery

## 9.3 Power Supply Recommendations

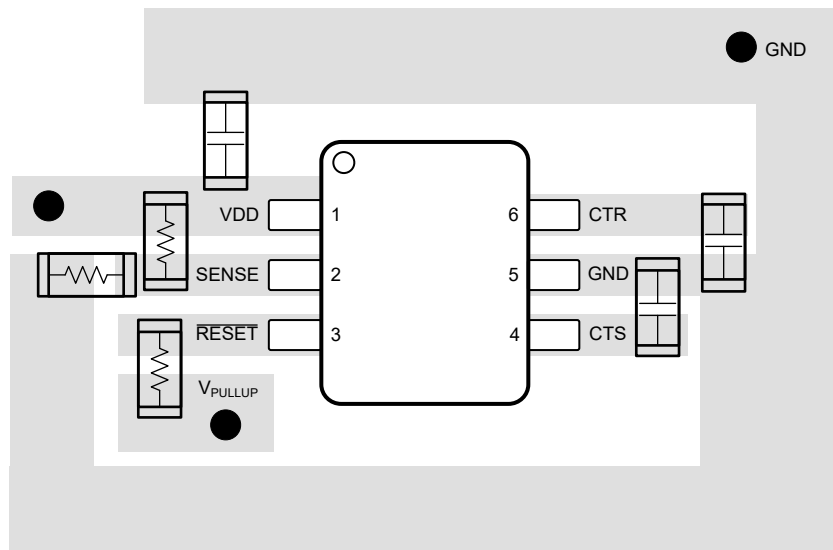
TPS3842-Q1 is designed to operate from an input supply with a  $V_{DD}$  voltage between 1.9V (minimum operation) to 42V (maximum operation). Good analog design practice recommends placing a minimum 0.1 $\mu$ F ceramic capacitor as near as possible to the  $V_{DD}$  pin.


## 9.4 Layout

### 9.4.1 Layout Guidelines

- Make sure that the connection to the VDD pin is low impedance. Good analog design practice is to place a greater than 0.1 $\mu$ F ceramic capacitor as near as possible to the VDD pin.
- For noisy environments and to improve noise immunity on the SENSE pins, an optional 1nF capacitor between the SENSE pin and GND can reduce the sensitivity to transient voltages on the monitored signal. An alternative to improve noise immunity is to use the CTS feature.
- If a capacitor is used on CTS or CTR, place these components as close as possible to the respective pins. If the capacitor adjustable pins are left unconnected, make sure to minimize the amount of parasitic capacitance to not affect the  $T_{PD}$  or  $t_{CTR}$ .
- Place the pull-up resistors on  $\overline{\text{RESET}}$  as close to the pin as possible.
- When laying out metal traces, separate high voltage traces from low voltage traces as much as possible.
- Do not have high voltage metal pads or traces closer than 20mils (0.5mm) to the low voltage metal pads or traces.

### 9.4.2 Layout Example



 Vias used to connect pins for application-specific connections

**Figure 9-3. TPS3842-Q1 Recommended Layout**

## 10 Device and Documentation Support

### 10.1 Device Support

### 10.2 Documentation Support

### 10.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 10.4 Trademarks

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### 10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 10.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
April 2024	*	Initial Release

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most-current data available for the designated devices. This data is subject to change without notice and without revision of this document. For browser-based versions of this data sheet, see the left-hand navigation pane.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PTPS3842A011DRLRQ1	ACTIVE	SOT-5X3	DRL	6	4000	TBD	Call TI	Call TI	-40 to 125		Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

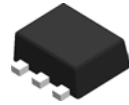
**OTHER QUALIFIED VERSIONS OF TPS3842-Q1 :**

- Catalog : [TPS3842](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

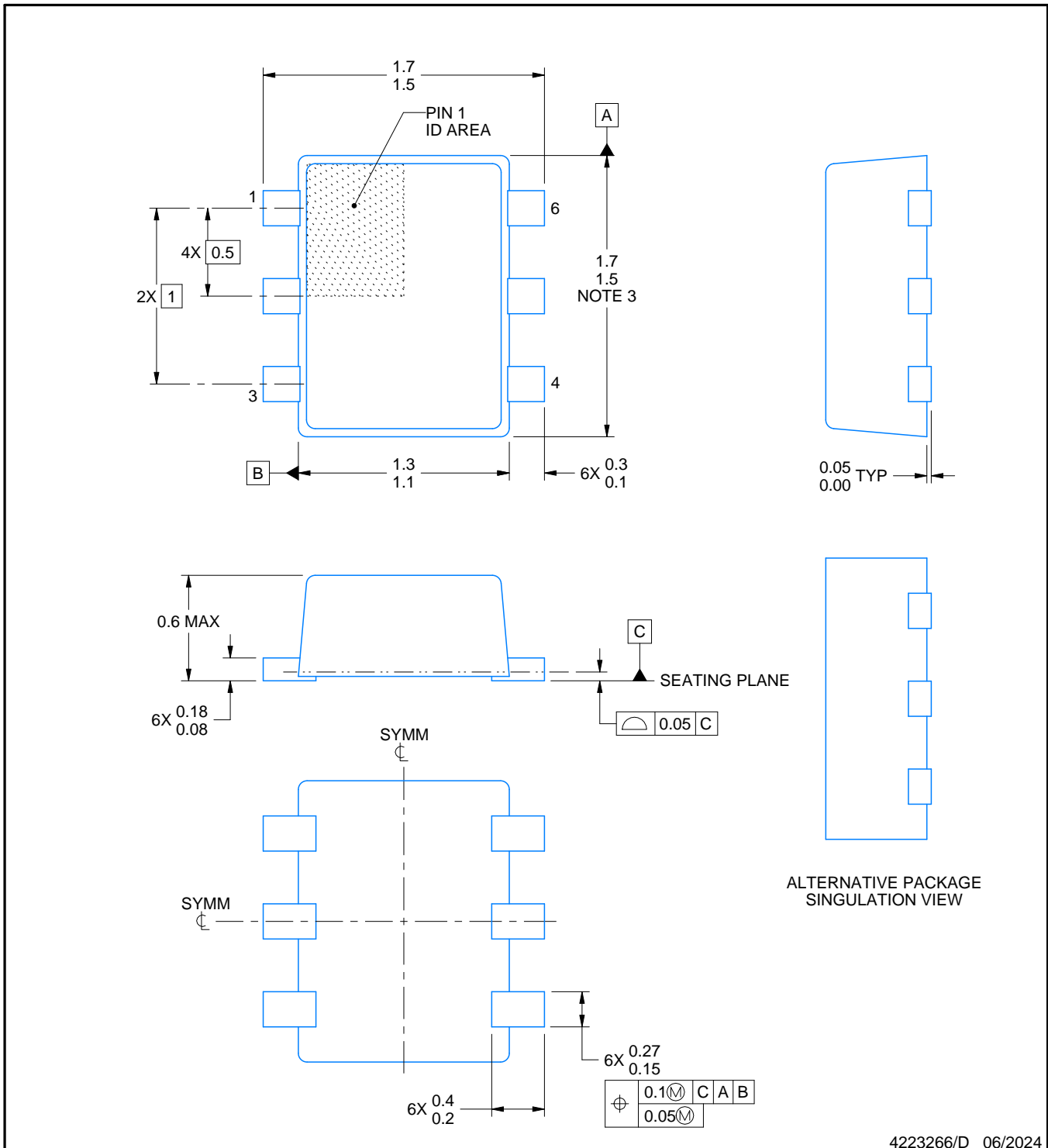
# DRL0006A



# PACKAGE OUTLINE

## SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



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### NOTES:

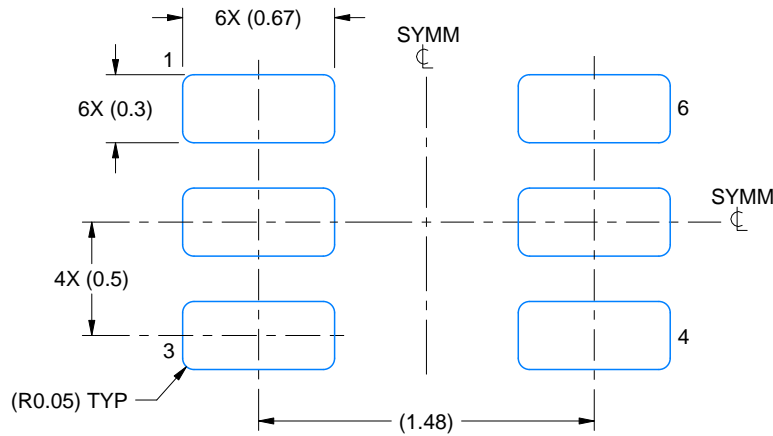
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-293 Variation UAAD

# EXAMPLE BOARD LAYOUT

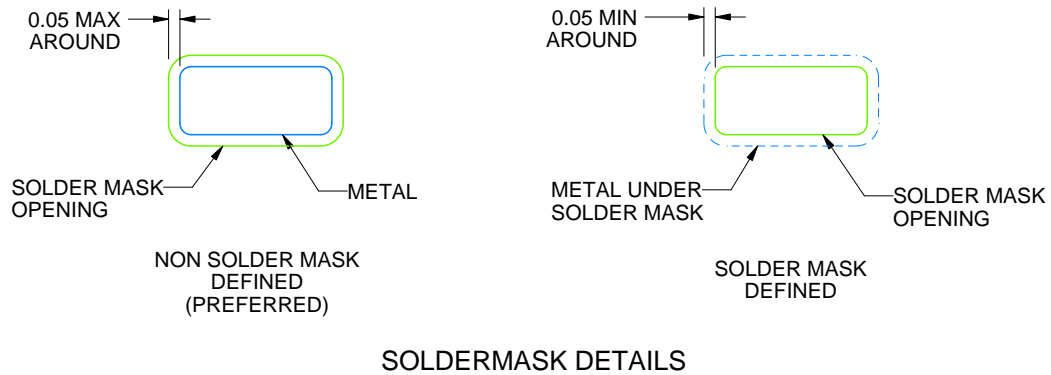
DRL0006A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



LAND PATTERN EXAMPLE  
SCALE:30X



SOLDERMASK DETAILS

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NOTES: (continued)

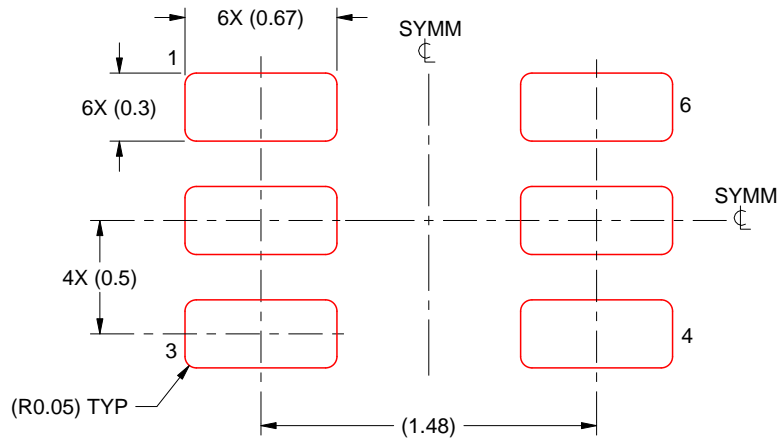
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
7. Land pattern design aligns to IPC-610, Bottom Termination Component (BTC) solder joint inspection criteria.

# EXAMPLE STENCIL DESIGN

DRL0006A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:30X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



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